

Docket No.: **HTK-0001**

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1. Name of conveying party(ies):

Shek C. Hong

2. Name and address of receiving party(ies):

Name: Hontek CorporationAddress: 161 South Satellite Road

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherCity: South Windsor State/Prov.: CTCountry: USA ZIP: 06074Execution Date: August 17, 2005

Additional name(s) & address(es)

☐ Yes ☒ No

4. Application number(s) or patent numbers(s):

If this document is being filed together with a new application, the execution date of the application is:

Patent Application No.

Filing date

B. Patent No.(s)

11/136,827

May 24, 2005

Additional numbers

☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: David E. RodriguesRegistration No. 50,604Address: Cantor Colburn LLP55 Griffin Road SouthCity: BloomfieldState/Prov.: CTCountry: USAZIP: 06002

6. Total number of applications and patents involved:

17. Total fee (37 CFR 3.41):.....\$ 40.00☐ Enclosed - Any excess or insufficiency should be credited or debited to deposit account☒ Authorized to be charged to deposit account

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To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

David E. Rodrigues

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August 19, 2005

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3

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ASSIGNMENT

WHEREAS I, Shek C. Hong (hereinafter referred to as "ASSIGNOR") of 212 Knollwood Drive, Glastonbury in the State of Connecticut; have invented certain new and useful improvements in:

ABRASION RESISTANT COATINGS

which claims priority to U.S. Provisional Application Serial No. 60/573,819 filed May 24, 2004 and U.S. Provisional Application Serial No. 60/649,443 filed February 2, 2005, and for which I am about to file an application for Letters Patent of the United States;

AND WHEREAS, HONTEK CORPORATION, (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the State of Connecticut, having a place of business at 161 South Satellite Road, South Windsor, CT 06074, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR, have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and I do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that I will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: _____

Aug. 17, 2005_____
Shek C. Hong_____
J.S.